



Technical Data Sheet

TOP LEDs

67-21 UYC/S530-XX/TR8

Features

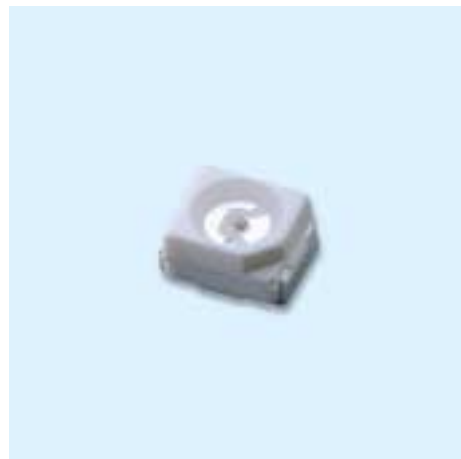
- P-LCC-2 package.
- White package.
- Optical indicator.
- Colorless clear window.
- Wide viewing angle.
- Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- Computable with automatic placement equipment.
- Available on tape and reel (8mm Tape).

Descriptions

- The 67-21 series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the SMT TOP LED ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

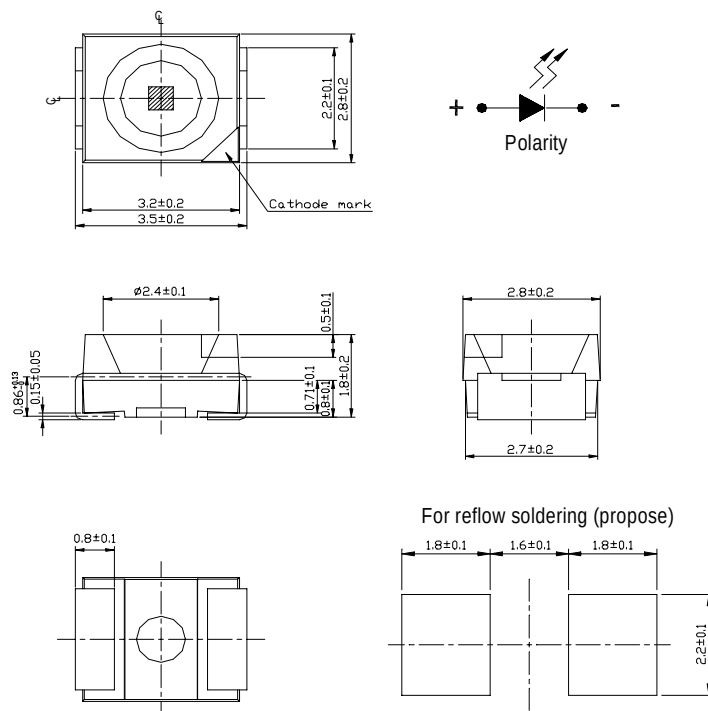
- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- Light pipe application.
- General use.



Device Selection Guide

Chip		Lens Color
Material	Emitted Color	
AlGaInP	Super Yellow	Water Clear

Package Dimensions



Notes: All dimensions are in millimeters.

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	25	mA
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Soldering Temperature	T _{sol}	260 (for 5 second)	°C
Electrostatic Discharge	ESD	2000	V
Power Dissipation	P _d	120	mW
Peak Forward Current(Duty 1/10 @ 1KHz)	I _F (Peak)	160	mA

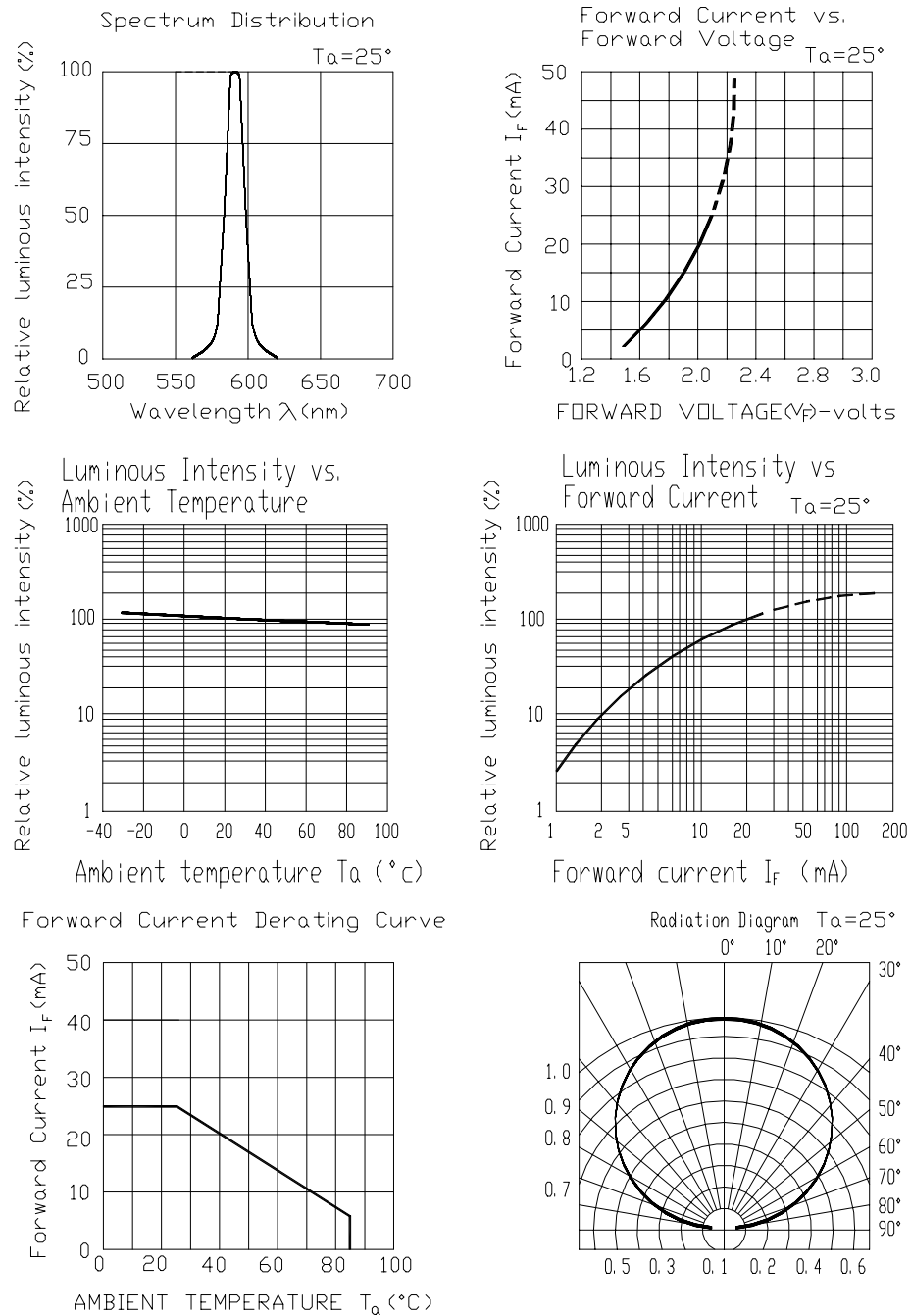
Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	*Chip Rank	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	A2	-----	2	-----	mcd	IF=2mA
			32	56	-----		IF=20mA
		A3	-----	3	-----		IF=2mA
			40	76	-----		IF=20mA
		A4	-----	4	-----		IF=2mA
			63	95	-----		IF=20mA
		A5	-----	5	-----		IF=2mA
			80	123	-----		IF=20mA
		A6	-----	7	-----		IF=2mA
			100	154	-----		IF=20mA
		A7	-----	8	-----		IF=2mA
			125	189	-----		IF=20mA
Viewing Angle	2 θ 1/2	-----	-----	120	-----	deg	IF=20mA
Peak Wavelength	λ p	-----	-----	591	-----	nm	IF=20mA
Dominant Wavelength	λ d	-----	-----	589	-----	nm	IF=20mA
Spectrum Radiation Bandwidth	△ λ	-----	-----	15	-----	nm	IF=20mA
Forward Voltage	V _F	-----	-----	2.0	2.4	V	IF=20mA
Reverse Current	I _R	-----	-----	-----	10	μ A	V _R =5V

***67-21UYC/S530-XX/TR8**

 Chip Rank

Typical Electro-Optical Characteristics Curves



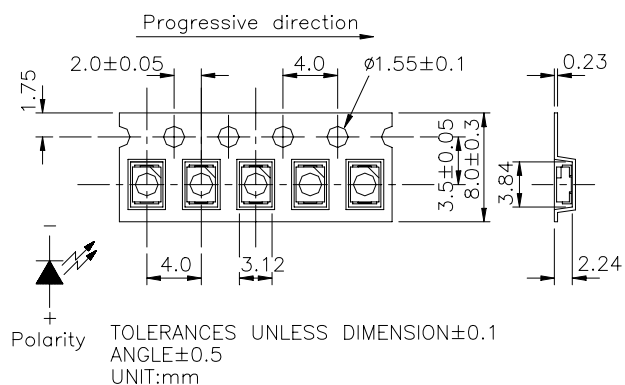
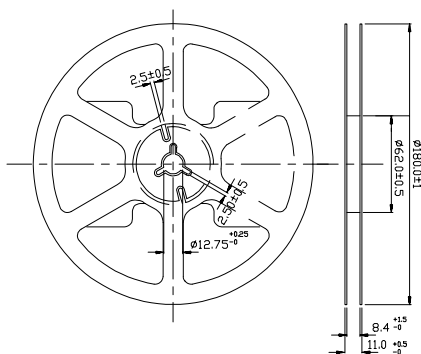
Reliability Test Items And Conditions

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Rc
1	Solder Heat	Temp. : $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$	5 Sec.	76 PCS.	0/1
2	Temperature Cycle	H : $+85^{\circ}\text{C}$ 30min ∫ 5 min L : -55°C 30min	50 Cycles	76 PCS.	0/1
3	Thermal Shock	H : $+100^{\circ}\text{C}$ 5min ∫ 10 sec L : -10°C 5min	50 Cycles	76 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	76 PCS.	0/1
5	Low Temperature Storage	Temp. : -55°C	1000 Hrs.	76 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	76 PCS.	0/1
7	High Temperature / High Humidity	$85^{\circ}\text{C} / \text{RH}85\%$	1000 Hrs.	76 PCS.	0/1

Products are evaluated according to the above standard reliability

Package Dimensions

Loaded quantity per reel 2000 PCS/reel



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage time

2.1 The operation of Temperature and RH are : $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, RH60%.

2.2 Once the package is opened, the products should be used within a week.

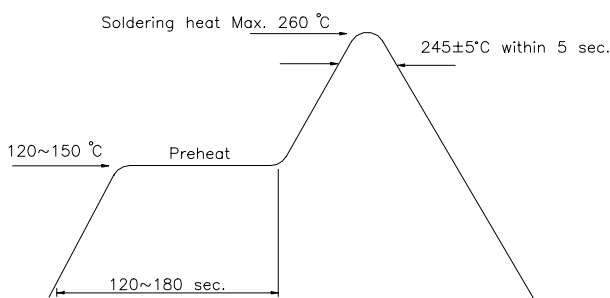
Otherwise, they should be kept in a damp proof box with desiccating agent.

Considering the tape life , we suggest our customers to use our products within a year(from production date).

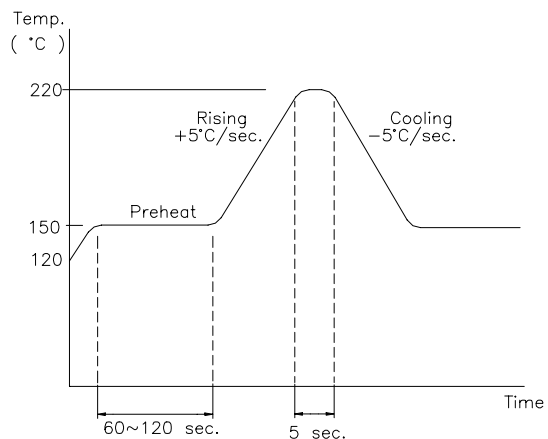
2.3 If opened more than one week in an atmosphere $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, RH 60%, they should be treated at $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 12hrs.

2.4 When you discover that the desiccant in the package has a pink color (Normal = blue) , you should treat them in the same conditions as 2.3.

Soldering heat reliability (DIP)



Reflow Temp. / Time

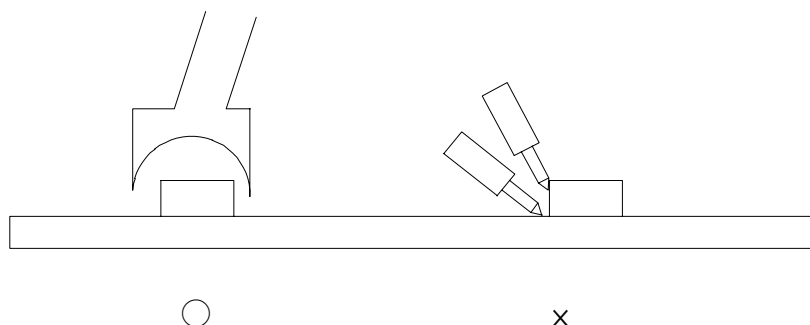


Soldering Iron

Basic spec is ≤ 5 sec when 245°C . If temperature is higher, time should be shorter ($+10^{\circ}\text{C} \rightarrow -1\text{sec}$). Power dissipation of Iron should be smaller than 15 W , and temperature should be controllable. Surface temperature of the device should be under 230°C .

Rework

1. Customer must finish rework within 5 sec under 245°C.
2. The head of iron can not touch copper foil.
3. Twin-head type is preferred.

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